Record of Letter Ballot Review by TC Chapter for Procedural Review

Region/Locale: Japan

Global Technical Committee: Silicon Wafer

TC Chapter Cochairs: T. Nakai/SUMCO, N. Kawai /Meiji University

Standards Staff: J. Collins

	Scheduled in Background Statement	Actual
Date	12/14/2017	12/14/2017
Location	Tokyo Big Sight, Tokyo Japan	Tokyo Big Sight, Tokyo Japan
Reason for Change of Date and/or Location (if changed)		

Note: See Regulations ¶ 9.5 Exception for allowable reason to change.

I. Document Number and Title

Document Number	Document Title
6265	REAPPROVAL OF SEMI M38-0312
	SPECIFICATION FOR POLISHED RECLAIMED
	SILICON WAFERS

II. Tally

Standards staff to fill in.

Voting Tally: As-cast tally after close of voting period

Note: A minimum of 60% of the Voting Interests that have TC Members within the global technical committee that issued the Letter Ballot must return Votes. (*Regulations* ¶ 9.7.1.1)

Voting Tally (with example values):

Voting Interest:	Returned Votes		Distribution		Return Rate	
Letter Ballot	57	÷	95	=	60.0%	≥60%
Intercommittee Ballot	25					
Voting Interest Reject(s)	0		Total	Vote	rs with Rejects	0
Voting Interest Accept(s)	31					

Note: See Regulations § 3.2.1 for definition of Voting Interest.

III. Rejects: No Rejects

IV. Other Technical Issues: None

Note: TC Chapter may choose to address a technical issue that is not part of a Negative received on a Letter Ballot (i.e., a Comment or a reason not addressed by a Vote response) by handling it as a Negative and finding it related and technically persuasive. The TC Chapter may then fail the Document or address such technical issue by using the procedure defined in *Regulations* § 9.6.4.3 to make a technical change to the Document. (*Regulations* ¶ 9.6.2.4.5)

V. Comments: None

VI. Editorial Changes Other than Those Voted on in § V: None

Original section/paragraph number and at least one full sentence are required in "FROM" and "TO" fields.

VII. Approval Conditions Check

VII. - (i). Approval Rate

APPROVAL CONDITION 1: All Negatives have been discussed and were withdrawn, found not related, found not persuasive, or addressed by a technical change. (*Regulations* ¶ 9.7.1.2)

APPROVAL CONDITION 2: At least 90% of the sum of valid Voting Interest Accept and Voting Interest Reject Votes must be Accept. (*Regulations* ¶ 9.7.1.3)

Note: If both approval conditions are not satisfied, the Document fails.

		Accepts		(Accepts + Valid Rejects)			
Approval Rate	=	31	1	31	=	100.0%	≥90%

VII. – (ii) Approval Level (check one)

Note: See *Regulations* § 9.7.2 for further information.

Globally Approved (No Ratification Ballot needed): The Letter Ballot meets the Letter Ballot approval condition

The Letter Ballot meets the Letter Ballot approval conditions for the global technical committee.

Need a Ratification Ballot:

The Letter Ballot meets the Letter Ballot approval conditions for the TC Chapter and a Ratification Ballot will be issued to validate technical changes.

VIII. Safety Check

Note: See Regulations § 15 for further information.

	x	Th is	This is not a Safety Document , when all safety-related information is removed, the Document is still technically sound and complete. (<i>Regulations</i> ¶ 8.7.1)						
Motion	This is a Safety Document, when all safety-related information is removed, the Document is not technically sound and complete. (Regulations ¶ 8.7.2)								
			Safety Checklist (<i>Regulations</i> ¶ 15.3) is complete and has been included with the Document throughout the balloting process. (<i>Regulations</i> ¶ 15.1.2)						
Motion by/2 nd by Ryuji 7			by/2 nd by	Ryuji Takeda (GlobalWafers Japan)/ Tsuyoshi Otsuki (SEH)					
Discussion			ussion	None					
Vote 11 Y-0 N; Motion passed				11 Y-0 N; Motion passed					

IX. Intellectual Property (IP) Check

Note: This Letter Ballot may cover all or part of a Standard or Safety Guideline. This IP check applies to the entire Standard or Safety Guideline. See *Regulations* § 16 for further information.

х		e TC Chapter meeting chair asked those participating, if they were aware of any potentially terial patented technology or copyrighted items* in the Standard or Guideline. (Regulations ¶ .1)									
	Х		otentially n righted iter		GO TO SECTION X.						
		GO TO SECTION X.									
		use o	of such ma	material patented technology or reproduction of copyrighted items is known and h materials is technically justified by the TC Chapter, but an LOA or copyright ter for some of the item(s) has NOT been obtained or presented to the TC Chap							
	N		Ask ISC f	or spec	or special permission to publish.						
	Motion		Quit activ	ity.							
	'n		Wait for L	.OA for	patented technology or release of copyrighted	d items.					
	Mot	ion by	y/2 nd by	Name (Company)/Name (Company)							
		iscus	ssion	XXXX							
		Vot	e	XX Y-XX N							
	Final Action				Motion passed						
	Г	iiiai A	CHOH		Motion failed						

^{*} Note: Such potentially material patented technology or copyrighted items might have become known since the Standard or Safety Guideline was last reviewed, or might become relevant due to this Letter Ballot.

X. Action for This Document

Motion	x	This Document passed TC Chapter review as balloted and will be forwarded to the ISC A&R SC for procedural review.
ion		This Document passed TC Chapter review with editorial changes and will be forwarded to the ISC A&R SC for procedural review.

Ratification Ballot will be issued to verify the technical ch	3						
This Document failed TC Chapter review and will be retu	This Document failed TC Chapter review and will be returned to the TF for rework.						
This Document failed TC Chapter review and work will be	pe discontinued.						
Motion by/ 2 nd by Ryuji Takeda (GlobalWafers Japan)/ Tsuyos	Ryuji Takeda (GlobalWafers Japan)/ Tsuyoshi Otsuki (SEH)						
Discussion	None						
Vote 11 Y-0 N							
Final Action							

Standards staff to record the result of the A&R procedural review here:

	Approved for publication
	Approved pending acceptance of the Ratification Ballot
	Not approved
Re	eason:
	Re